V8PL6-M3

Vishay General Semiconductor

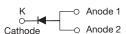
# High Current Density Surface Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.34$  V at  $I_F = 4$  A



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### SMPC (TO-277A)



## **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	8.0 A			
V <sub>RRM</sub>	60 V			
I <sub>FSM</sub>	140 A			
$V_F$ at $I_F$ = 8.0 A ( $T_A$ = 125 °C)	0.42 V			
T <sub>J</sub> max.	150 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

## FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## **MECHANICAL DATA**

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8PL6-M3	UNIT	
Device marking code		8L6		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum average forward rectified current (fig. 1)	I <sub>F</sub> <sup>(1)</sup>	8.0	A	
	I <sub>F</sub> <sup>(2)</sup>	4.3		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	140	А	
Voltage rate of change (rated V <sub>R</sub> )	dV/dt	10 000	V/µs	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Notes

<sup>(1)</sup> Mounted on 30 mm x 30 mm pad areas aluminum PCB

<sup>(2)</sup> Free air, mounted on recommended copper pad area

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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.43	-	V
	I <sub>F</sub> = 8.0 A			0.50	0.58	
	I <sub>F</sub> = 4.0 A	– T <sub>A</sub> = 125 °C		0.34	-	
	I <sub>F</sub> = 8.0 A			0.42	0.52	
Reverse current	V 60 V	= 60 V $T_{A} = 25 °C$ $T_{A} = 125 °C$	I <sub>R</sub> <sup>(2)</sup>	-	2.4	mA
	$v_{\rm R} = 60 v$			21	55	

Notes

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PL6-M3	UNIT	
Typical thermal registerion	R <sub>0JA</sub> <sup>(1) (2)</sup>	75	°C/W	
Typical thermal resistance	R <sub>0JM</sub> <sup>(3)</sup>	4		

Notes

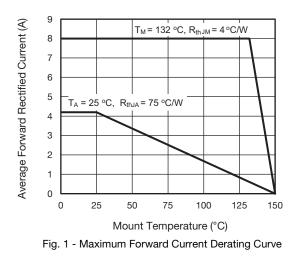
<sup>(1)</sup> Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta,JA}$  - junction-to-ambient

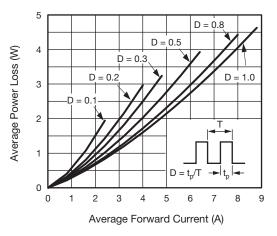
<sup>(2)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

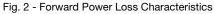
<sup>(3)</sup> Mounted on 30 mm x 30 mm AI PCB; thermal resistance  $R_{\theta JM}$  - junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PL6-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V8PL6-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	

# **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)











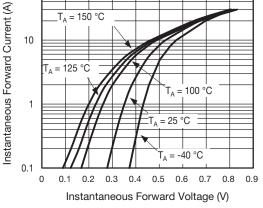


Fig. 3 - Typical Instantaneous Forward Characteristics

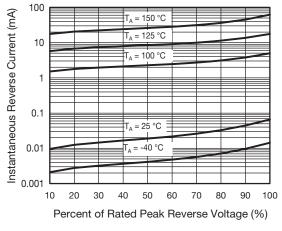


Fig. 4 - Typical Reverse Leakage Characteristics

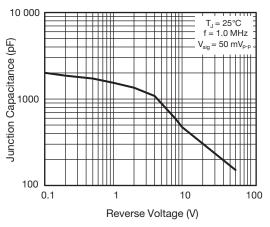
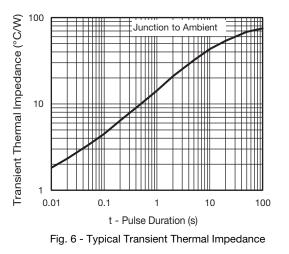


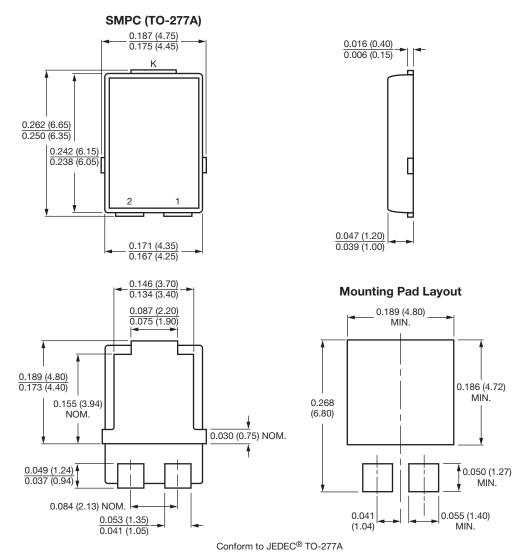
Fig. 5 - Typical Junction Capacitance



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# PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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